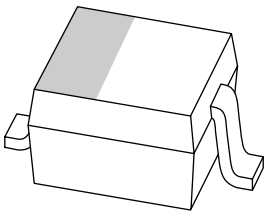
DATA SHEET



BZX384 series
Voltage regulator diodes

Product data sheet
Supersedes data of 2003 Apr 01

2004 Mar 22

NXP founded by Philips

MARKING

TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE
Marking codes for BZX384-B2V4 to BZX384-B75							
BZX384-B2V4	K1	BZX384-B6V2	L2	BZX384-B16	M3	BZX384-B43	N3
BZX384-B2V7	K2	BZX384-B6V8	L3	BZX384-B18	M4	BZX384-B47	N4
BZX384-B3V0	K3	BZX384-B7V5	L4	BZX384-B20	M5	BZX384-B51	N5
BZX384-B3V3	K4	BZX384-B8V2	L5	BZX384-B22	M6	BZX384-B56	N6
BZX384-B3V6	K5	BZX384-B9V1	L6	BZX384-B24	M7	BZX384-B62	N7
BZX384-B3V9	K6	BZX384-B10	L7	BZX384-B27	M8	BZX384-B68	N8
BZX384-B4V3	K7	BZX384-B11	L8	BZX384-B30	M9	BZX384-B75	N9
BZX384-B4V7	K8	BZX384-B12	L9	BZX384-B33	N0		
BZX384-B5V1	K9	BZX384-B13	M1	BZX384-B36	N1		
BZX384-B5V6	L1	BZX384-B15	M2	BZX384-B39	N2		
Marking codes for BZX384-C2V4 to BZX384-C75							
BZX384-C2V4	T3	BZX384-C6V2	T1	BZX384-C16	DE	BZX384-C43	DR
BZX384-C2V7	T4	BZX384-C6V8	D7	BZX384-C18	DF	BZX384-C47	DS
BZX384-C3V0	T5	BZX384-C7V5	D8	BZX384-C20	DG	BZX384-C51	DT
BZX384-C3V3	T6	BZX384-C8V2	D9	BZX384-C22	DH	BZX384-C56	DU
BZX384-C3V6	T7	BZX384-C9V1	D0	BZX384-C24	DJ	BZX384-C62	DV
BZX384-C3V9	T8	BZX384-C10	T2	BZX384-C27	DK	BZX384-C68	DW
BZX384-C4V3	T9	BZX384-C11	DA	BZX384-C30	DL	BZX384-C75	DX
BZX384-C4V7	T0	BZX384-C12	DB	BZX384-C33	DM		
BZX384-C5V1	D5	BZX384-C13	DC	BZX384-C36	DN		
BZX384-C5V6	D6	BZX384-C15	DD	BZX384-C39	DP		

ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
BZX384-B2V4 to BZX384-B75	–	plastic surface mounted package; 2 leads	SOD323
BZX384-C2V4 to BZX384-C75			

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_F	continuous forward current		–	250	mA
I_{ZSM}	non-repetitive peak reverse current	t_p = 100 μs; square wave; T_{amb} = 25 °C; prior to surge	see Tables 1 and 2		A
P_{ZSM}	non-repetitive peak reverse power dissipation	t_p = 100 μs; square wave; T_{amb} = 25 °C; prior to surge	–	40	W
P_{tot}	total power dissipation	T_{amb} = 25 °C; note 1	–	300	mW
T_{stg}	storage temperature		−65	+150	°C
T_j	junction temperature		−65	+150	°C

Note

1. Refer to SOD323 standard mounting conditions.

CHARACTERISTICS

Total BZX384-B and C series

T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V_F	forward voltage	I_F = 10 mA; see Fig.3	0.9	V
		I_F = 100 mA; see Fig.3	1.1	V
I_R	reverse current;			
	BZX384-B/C2V4	V_R = 1 V	50	μA
	BZX384-B/C2V7	V_R = 1 V	20	μA
	BZX384-B/C3V0	V_R = 1 V	10	μA
	BZX384-B/C3V3	V_R = 1 V	5	μA
	BZX384-B/C3V6	V_R = 1 V	5	μA
	BZX384-B/C3V9	V_R = 1 V	3	μA
	BZX384-B/C4V3	V_R = 1 V	3	μA
	BZX384-B/C4V7	V_R = 2 V	3	μA
	BZX384-B/C5V1	V_R = 2 V	2	μA
	BZX384-B/C5V6	V_R = 2 V	1	μA
	BZX384-B/C6V2	V_R = 4 V	3	μA
	BZX384-B/C6V8	V_R = 4 V	2	μA
	BZX384-B/C7V5	V_R = 5 V	1	μA
	BZX384-B/C8V2	V_R = 5 V	700	nA
	BZX384-B/C9V1	V_R = 6 V	500	nA
	BZX384-B/C10	V_R = 7 V	200	nA
	BZX384-B/C11	V_R = 8 V	100	nA
	BZX384-B/C12	V_R = 8 V	100	nA
	BZX384-B/C13	V_R = 8 V	100	nA
	BZX384-B/C15 to 75	$V_R = 0.7V_{Znom}$	50	nA

Table 1 Per type BZX384-**B/C2V4** to **B/C24**

T_j = 25 °C unless otherwise specified.

BZX-Bxxx Cxxx	WORKING VOLTAGE V_Z (V) at I_{Ztest} = 5 mA				DIFFERENTIAL RESISTANCE r_{dif} (Ω)				TEMPERATURE COEFFICIENT S_Z (mV/K) at I_{Ztest} = 5 mA (see Figs 4 and 5)			DIODE CAP. C_d (pF) at f = 1 MHz; V_R = 0 V	NON-REPETITIVE PEAK REVERSE CURRENT I_{ZSM} (A) at t_p = 100 μs; T_{amb} = 25 °C
	Tol. ±2% (B)		Tol. ±5% (C)		at I_{Ztest} = 1 mA		at I_{Ztest} = 5 mA						
	MIN.	MAX.	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.	MIN.	TYP.	MAX.	MAX.	MAX.
2V4	2.35	2.45	2.2	2.6	275	600	70	100	−3.5	−1.6	0	450	6.0
2V7	2.65	2.75	2.5	2.9	300	600	75	100	−3.5	−2.0	0	450	6.0
3V0	2.94	3.06	2.8	3.2	325	600	80	95	−3.5	−2.1	0	450	6.0
3V3	3.23	3.37	3.1	3.5	350	600	85	95	−3.5	−2.4	0	450	6.0
3V6	3.53	3.67	3.4	3.8	375	600	85	90	−3.5	−2.4	0	450	6.0
3V9	3.82	3.98	3.7	4.1	400	600	85	90	−3.5	−2.5	0	450	6.0
4V3	4.21	4.39	4.0	4.6	410	600	80	90	−3.5	−2.5	0	450	6.0
4V7	4.61	4.79	4.4	5.0	425	500	50	80	−3.5	−1.4	0.2	300	6.0
5V1	5.00	5.20	4.8	5.4	400	480	40	60	−2.7	−0.8	1.2	300	6.0
5V6	5.49	5.71	5.2	6.0	80	400	15	40	−2.0	1.2	2.5	300	6.0
6V2	6.08	6.32	5.8	6.6	40	150	6	10	0.4	2.3	3.7	200	6.0
6V8	6.66	6.94	6.4	7.2	30	80	6	15	1.2	3.0	4.5	200	6.0
7V5	7.35	7.65	7.0	7.9	30	80	6	15	2.5	4.0	5.3	150	4.0
8V2	8.04	8.36	7.7	8.7	40	80	6	15	3.2	4.6	6.2	150	4.0
9V1	8.92	9.28	8.5	9.6	40	100	6	15	3.8	5.5	7.0	150	3.0
10	9.80	10.20	9.4	10.6	50	150	8	20	4.5	6.4	8.0	90	3.0
11	10.80	11.20	10.4	11.6	50	150	10	20	5.4	7.4	9.0	85	2.5
12	11.80	12.20	11.4	12.7	50	150	10	25	6.0	8.4	10.0	85	2.5
13	12.70	13.30	12.4	14.1	50	170	10	30	7.0	9.4	11.0	80	2.5
15	14.70	15.30	13.8	15.6	50	200	10	30	9.2	11.4	13.0	75	2.0
16	15.70	16.30	15.3	17.1	50	200	10	40	10.4	12.4	14.0	75	1.5
18	17.60	18.40	16.8	19.1	50	225	10	45	12.4	14.4	16.0	70	1.5
20	19.60	20.40	18.8	21.2	60	225	15	55	14.4	16.4	18.0	60	1.5
22	21.60	22.40	20.8	23.3	60	250	20	55	16.4	18.4	20.0	60	1.25
24	23.50	24.50	22.8	25.6	60	250	25	70	18.4	20.4	22.0	55	1.25

Table 2 Per type BZX384-**B/C27** to **B/C75**

T_j = 25 °C unless otherwise specified.

BZX-Bxxx Cxxx	WORKING VOLTAGE V_Z (V) at I_{Ztest} = 2 mA				DIFFERENTIAL RESISTANCE r_{dif} (Ω)				TEMPERATURE COEFFICIENT S_Z (mV/K) at I_{Ztest} = 2 mA (see Figs 4 and 5)			DIODE CAP. C_d (pF) at f = 1 MHz; V_R = 0 V	NON-REPETITIVE PEAK REVERSE CURRENT I_{ZSM} (A) at t_p = 100 μs; T_{amb} = 25 °C
	Tol. ±2% (B)		Tol. ±5% (C)		at I_{Ztest} = 0.5 mA		at I_{Ztest} = 2 mA						
	MIN.	MAX.	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.	MIN.	TYP.	MAX.	MAX.	MAX.
27	26.50	27.50	25.1	28.9	65	300	25	80	21.4	23.4	25.3	50	1.0
30	29.40	30.60	28.0	32.0	70	300	30	80	24.4	26.6	29.4	50	1.0
33	32.30	33.70	31.0	35.0	75	325	35	80	27.4	29.7	33.4	45	0.9
36	35.30	36.70	34.0	38.0	80	350	35	90	30.4	33.0	37.4	45	0.8
39	38.20	39.80	37.0	41.0	80	350	40	130	33.4	36.4	41.2	45	0.7
43	42.10	43.90	40.0	46.0	85	375	45	150	37.6	41.2	46.6	40	0.6
47	46.10	47.90	44.0	50.0	85	375	50	170	42.0	46.1	51.8	40	0.5
51	50.00	52.00	48.0	54.0	90	400	60	180	46.6	51.0	57.2	40	0.4
56	54.90	57.10	52.0	60.0	100	425	70	200	52.2	57.0	63.8	40	0.3
62	60.80	63.20	58.0	66.0	120	450	80	215	58.8	64.4	71.6	35	0.3
68	66.60	69.40	64.0	72.0	150	475	90	240	65.6	71.7	79.8	35	0.25
75	73.50	76.50	70.0	79.0	170	500	95	255	73.4	80.2	88.6	35	0.2

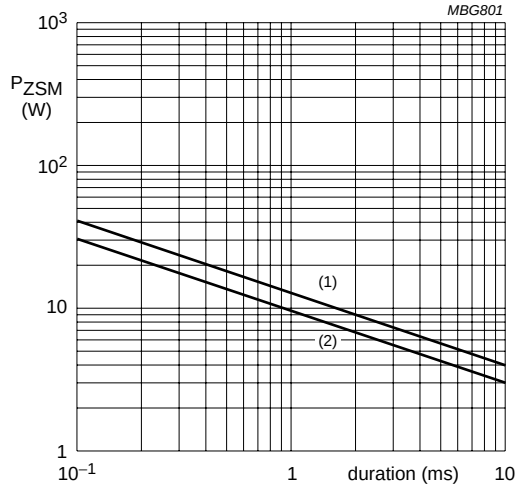
THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th(j-a)}$	thermal resistance from junction to ambient	note 1	415	K/W
$R_{th(j-s)}$	thermal resistance from junction to soldering point	note 2	110	K/W

Notes

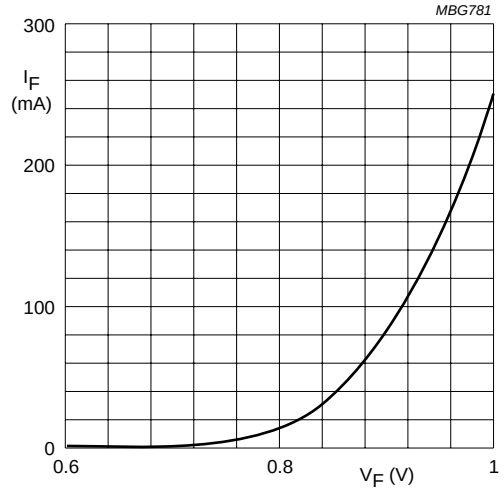
1. Device mounted on an FR4 printed-circuit board.
2. Soldering point of the cathode tab.

GRAPHICAL DATA



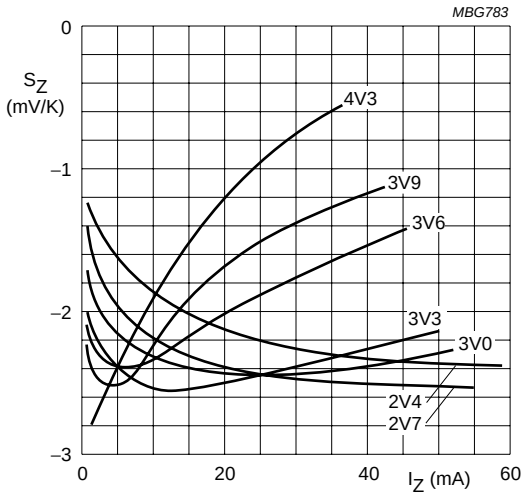
(1) T_j = 25 °C (prior to surge).
(2) T_j = 150 °C (prior to surge).

Fig.2 Maximum permissible non-repetitive peak reverse power dissipation versus duration.



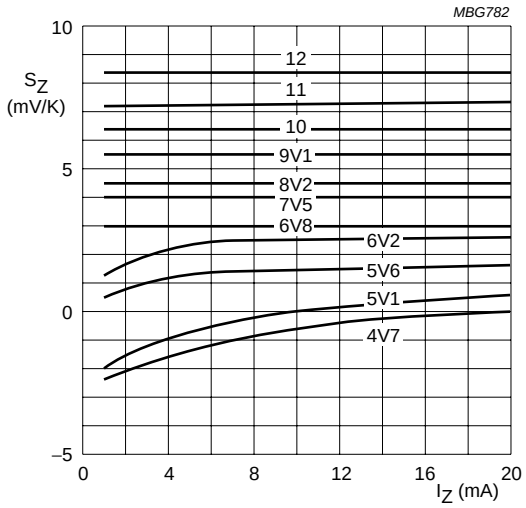
T_j = 25 °C.

Fig.3 Forward current as a function of forward voltage; typical values.



BZX384-B/C2V4 to B/C4V3.
T_j = 25 to 150 °C.

Fig.4 Temperature coefficient as a function of working current; typical values.

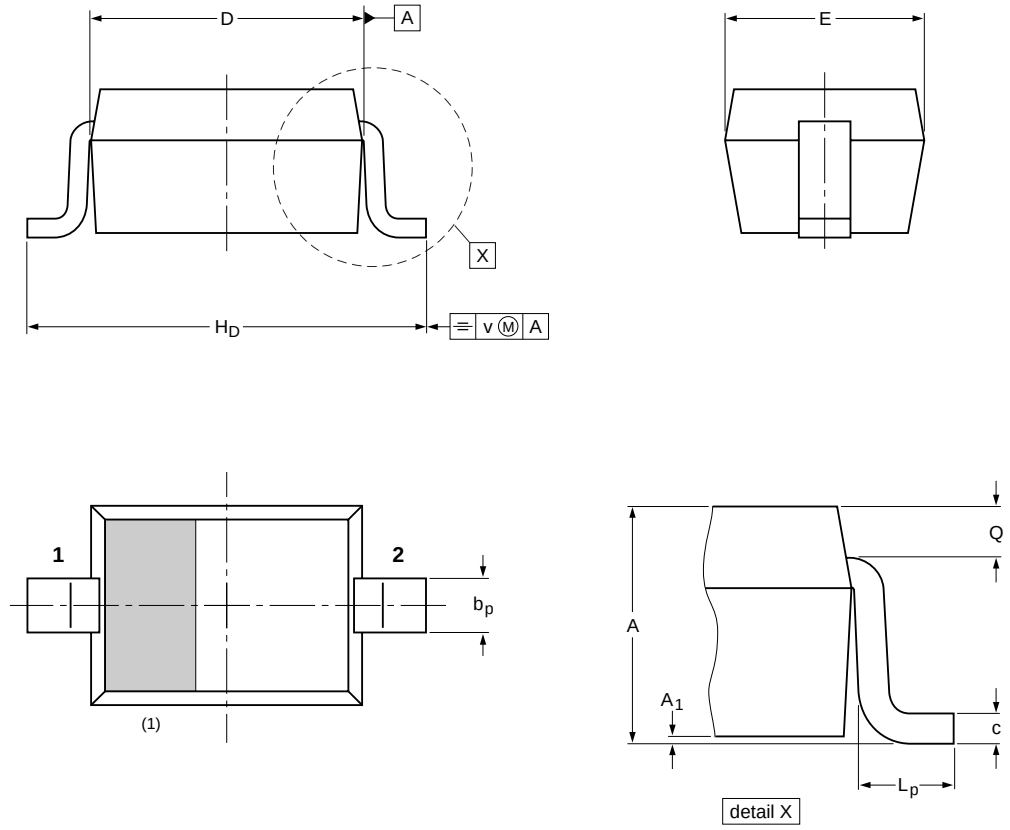


BZX384-B/C4V7 to B/C12.
T_j = 25 to 150 °C.

Fig.5 Temperature coefficient as a function of working current; typical values.

PACKAGE OUTLINE

Plastic surface-mounted package; 2 leads **SOD323**



DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1 max	b_p	c	D	E	H_D	L_p	Q	v
mm	1.1 0.8	0.05	0.40 0.25	0.25 0.10	1.8 1.6	1.35 1.15	2.7 2.3	0.45 0.15	0.25 0.15	0.2

Note

1. The marking bar indicates the cathode

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOD323			SC-76			~~03-12-17~~ 06-03-16

DATA SHEET STATUS

DOCUMENT STATUS[1]	PRODUCT STATUS[2]	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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